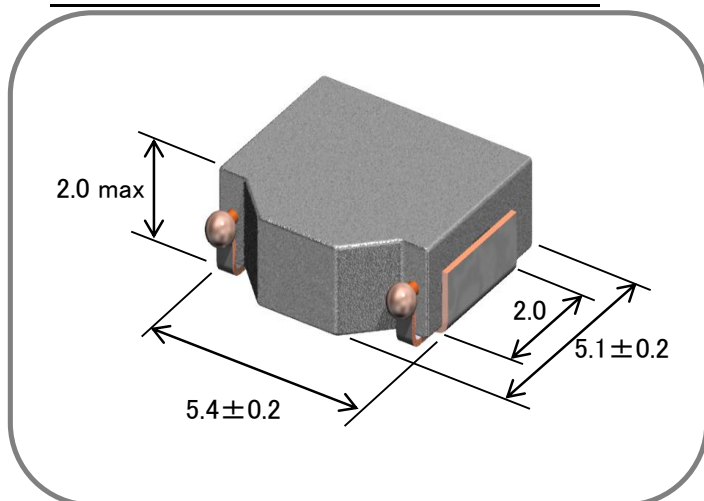


Component Image & Dimension



Features

- a) Small Footprint and Low Profile Design :
Footprint : 5.4 x 5.1 mm Typ.
Height : 2.0mm Max.
- b) High Power Handling Capability :
Small Copper Loss
Using Large Saturation Induction of Fe- based metals
- c) Flat inductance performance over temperature based on the high curie temperature of the iron powder core material.
- d) Automatic Mounting in Tape&Reel Package.

Applications

Note Book & Mobile Computer, VRM, Cellular Phone, HDD, Car accessories etc.

Electrical Specification

TDK Identification	Inductance		Test Freq.	DC Resistance		Rated DC Current		
	at 0A	Tol.		Spec.	Typ.	Idc 1	Idc 2	
	(uH)	(%)	(kHz)	(m-Ohm)	(m-Ohm)	(A) max.	(A) typ.	(A) typ.
SPM5020T- R47M-CA	0.47	+/-20%	100	18.5 max	16.8	13.6	18.1	6.9
SPM5020T- 1R0M-CA	1.0	+/-20%	100	25.3 max	23.0	8.3	11.0	6.0
SPM5020T- 1R5M-CA	1.5	+/-20%	100	33.4 max	30.4	7.8	10.4	5.0
SPM5020T- 2R2M-CA	2.2	+/-20%	100	51.4 max	46.7	5.5	7.3	4.2
SPM5020T- 3R3M-CA	3.3	+/-20%	100	66.3 max	60.3	5.2	7.0	3.8
SPM5020T- 4R7M-CA	4.7	+/-20%	100	74.0 max	67.3	4.1	5.5	3.4

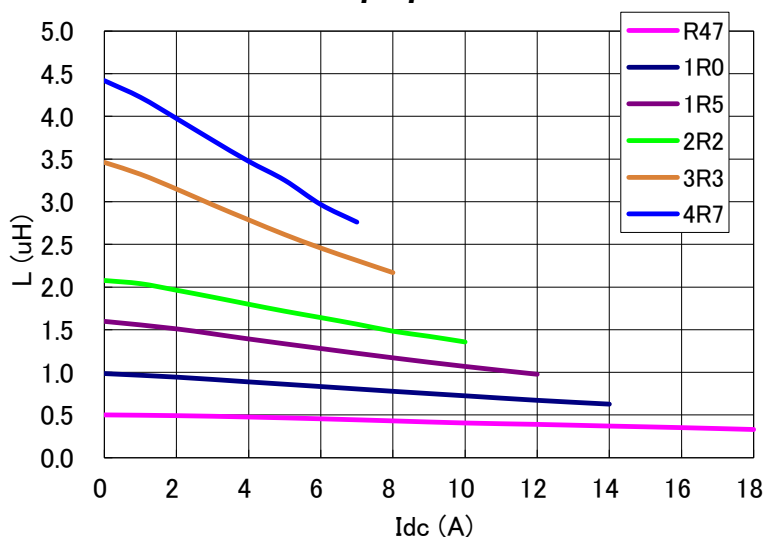
Note. Idc 1 : Based on the inductance change.(-30% Reduction from Nominal L Value)

Idc 2 : Based on the self temperature rise. (+40 deg typ.)

Operating Temperature Range: -40 °C ~ +125 °C (including self temperature rise)

Caution: Please contact our sales person when you consider organic solvent or aqueous cleaning.

Inductance vs.DC Superposition



Recommended pad layout

